

HOSTAFORM® C 52021 LS - POM

Description

POM copolymer Extremely easy flowing Injection molding type for very thin-walled precision molded parts with unfavourite flow-path-wall thickness relation; permits processing at reduced temperature and also shorter cycle times; for mechanical lower requirements; good chemical resistance to solvents, fuel and strong alkalis as well as good hydrolysis resistance; high esistance to thermal and oxidative degradation. With UV Additives Ranges of applications: For very thin-walled precision molded parts with unfavourite flow-path-wall thickness relation; permits processing at reduced temperature and also shorter cycle times.

Physical properties	Value	Unit	Test Standard
Density	1410	kg/m³	ISO 1183
Melt volume rate, MVR	39	cm³/10min	ISO 1133
MVR temperature	190	°C	ISO 1133
MVR load	2.16	kg	ISO 1133
Molding shrinkage, parallel	1.9	%	ISO 294-4, 2577
Molding shrinkage, normal	1.8	%	ISO 294-4, 2577
Water absorption, 23°C-sat	0.65	%	ISO 62
Humidity absorption, 23°C/50%RH	0.2	%	ISO 62

Mechanical properties	Value	Unit	Test Standard
Tensile modulus	3000	MPa	ISO 527-2/1A
Tensile stress at yield, 50mm/min	65	MPa	ISO 527-2/1A
Tensile strain at yield, 50mm/min	7	%	ISO 527-2/1A
Tensile nominal strain at break, 50mm/min	15	%	ISO 527-2/1A
Tensile creep modulus, 1h	2500	MPa	ISO 899-1
Tensile creep modulus, 1000h	1300	MPa	ISO 899-1
Flexural modulus, 23°C	2800	MPa	ISO 178
Charpy impact strength, 23°C	150	kJ/m²	ISO 179/1eU
Charpy impact strength, -30°C	150	kJ/m²	ISO 179/1eU
Charpy notched impact strength, 23°C	5	kJ/m²	ISO 179/1eA
Charpy notched impact strength, -30°C	5	kJ/m²	ISO 179/1eA
Ball indentation hardness, 30s	148	MPa	ISO 2039-1

Thermal properties	Value	Unit	Test Standard
Melting temperature, 10°C/min	166	°C	ISO 11357-1/-3
DTUL at 1.8 MPa	106	°C	ISO 75-1, -2
Vicat softening temperature, 50°C/h 50N	151	°C	ISO 306
Coeff. of linear therm expansion, parallel	1.1	E-4/°C	ISO 11359-2

Electrical properties	Value	Unit	Test Standard
Relative permittivity, 100Hz	4	-	IEC 60250
Relative permittivity, 1MHz	4	-	IEC 60250
Dissipation factor, 100Hz	30	E-4	IEC 60250
Dissipation factor, 1MHz	50	E-4	IEC 60250
Volume resistivity	1E12	Ohm*m	IEC 60093
Surface resistivity	1E14	Ohm	IEC 60093
Electric strength	35	kV/mm	IEC 60243-1
Comparative tracking index	600	-	IEC 60112

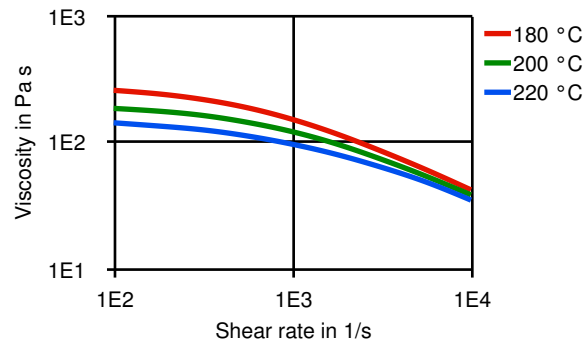
Rheological calculation properties	Value	Unit	Test Standard
Density of melt	1200	kg/m³	Internal
Thermal conductivity of melt	0.19	W/(m K)	Internal
Spec. heat capacity melt	2060	J/(kg K)	Internal
Ejection temperature	140	°C	Internal



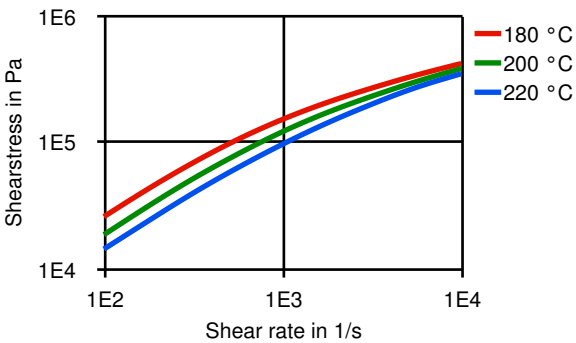
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Diagrams

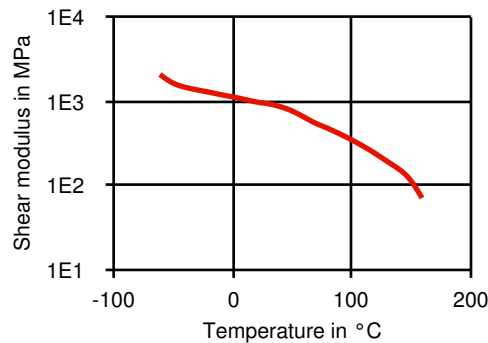
Viscosity-shear rate



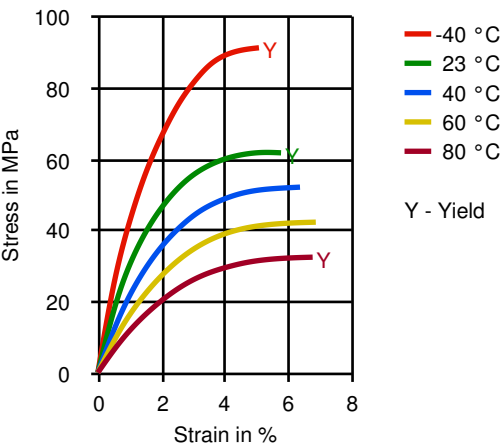
Shearstress-shear rate



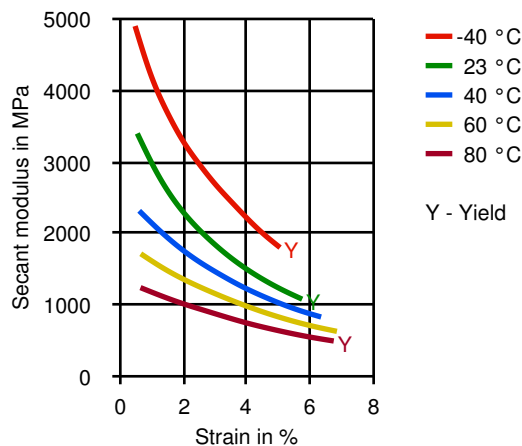
Dynamic Shear modulus-temperature



Stress-strain



Secant modulus-strain



Typical injection moulding processing conditions

Pre Drying	Value	Unit	Test Standard
Necessary low maximum residual moisture content	0.15	%	-
Drying time	3 - 4	h	-
Drying temperature	100 - 120	°C	-



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Temperature	Value	Unit	Test Standard
Hopper temperature	20 - 30	°C	-
Feeding zone temperature	60 - 80	°C	-
Zone1 temperature	170 - 180	°C	-
Zone2 temperature	180 - 190	°C	-
Zone3 temperature	190 - 200	°C	-
Zone4 temperature	190 - 210	°C	-
Nozzle temperature	190 - 210	°C	-
Melt temperature	190 - 210	°C	-
Mold temperature	80 - 120	°C	-
Hot runner temperature	190 - 210	°C	-
Pressure	Value	Unit	Test Standard
Back pressure max.	40	bar	-
Speed	Value	Unit	Test Standard
Injection speed	slow-medium	-	-
Screw Speed	Value	Unit	Test Standard
Screw speed diameter, 25mm	150	RPM	-
Screw speed diameter, 40mm	100	RPM	-
Screw speed diameter, 55mm	70	RPM	-

Other text information

Pre-drying

Drying is not normally required. If material has come in contact with moisture through improper storage or handling or through regrind use, drying may be necessary to prevent splay and odor problems.

Longer pre-drying times/storage

The product can then be stored in standard conditions until processed.

Characteristics

Special Characteristics

UV resistant

Delivery Form

Pellets

Processing

Injection molding

Additives

Release agent

